



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/043,896	01/09/2002	Kevin K. Lee	113025-120US2	7745

7590 06/07/2005

Matthew E. Connors
Gauthier & Connors LLP
225 Franklin Street
Suite 3300
Boston, MA 02110

EXAMINER

WANG, GEORGE Y

ART UNIT PAPER NUMBER

2871

DATE MAILED: 06/07/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No. 10/043,896	Applicant(s) LEE ET AL.	
	Examiner George Y. Wang	Art Unit 2871	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 13 October 2004.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-42 is/are pending in the application.
- 4a) Of the above claim(s) 28-35 and 39 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-27, 36-38 and 40-42 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 30 June 2003 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on October 13, 2004 has been entered.

Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to

Art Unit: 2871

consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

3. Claims 1-4, 14-16, 27, 36, and 40-42 are rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Admission of Prior Art (AAPA) in view of Wojnarowski et al. (U.S. Patent No. 5,737,458, from hereinafter "Wojnarowski").

4. As to claim 1, AAPA discloses an optical chip (pg. 1, lines 17-18) having at least one large mode field size dielectric waveguide (fig. 1; pg. 1, lines 17-18) that interfaces with an external optical device (pg. 1, lines 20-22), at least one low minimum bending radius dielectric waveguide (pg. 2, lines 15-17), and at least one optical function (pg. 1, lines 17-18) connected to the low minimum bending radius dielectric waveguide.

However, AAPA fails to disclose the large mode field size dielectric waveguide, the low minimum bending radius dielectric waveguide, and the optical function being fabricated monolithically on a single substrate.

Wojnarowski discloses an optical chip with dielectric waveguides (col. 2, lines 14-16) and optical function devices (fig. 2, ref. 50, 52) are fabricated monolithically on a single substrate (fig. 2, ref. 54).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to arrange a large mode field size dielectric waveguide, a low minimum bending radius dielectric waveguide, and an optical function monolithically on a single substrate since one would be motivated to provide an optimum platform for a

high density interconnect structure (col. 1, lines 20-35). This not only provides stability but also high compatibility with many other interconnections, including external waveguides and optical devices (col. 2, lines 61-67).

5. Regarding claims 2-4 and 14-16, AAPA discloses an external optical device that is a low index difference dielectric waveguide, which is edge emitting/receiving, and provides input from an external optical chip (pg. 1, lines 20-22; fig. 1). Furthermore, AAPA discloses this large mode field size dielectric waveguide, which is also a low index difference dielectric waveguide, having a low index core and cladding that are related by the following expression: $1 < ([n_1 - n_3]/n_3) < 0.1$ (fig. 1; pg. 1, line 22 – pg. 2, line 14). AAPA also discloses the low minimum bending radius dielectric waveguide, which is a high index difference dielectric waveguide, having a high index core and cladding that are related by the following expression: $0.1\alpha([n_2 - n_3]/n_3)$ (pg. 2, lines 15-24).

6. Regarding claims 17-19, AAPA discloses a large mode field size dielectric waveguide having a low index core and cladding that are related by the following expression: $1 < ([n_1 - n_3]/n_3) < 0.1$ (fig. 1; pg. 1, line 22 – pg. 2, line 14) and a low minimum bending radius dielectric waveguide i having a high index core and cladding that are related by the following expression: $0.1\alpha([n_2 - n_3]/n_3)$ (pg. 2, lines 15-24).

However, AAPA fails to disclose a large mode field size dielectric waveguide having a low index core and cladding that are related by the following expression: $0 < ([n_1 - n_3]/n_3) < 0.04$ or $0 < ([n_1 - n_3]/n_3) < 0.01$ and a low minimum bending radius dielectric

Art Unit: 2871

waveguide having a high index core and cladding that are related by the following expression: $0.3\alpha([n_2-n_3]/n_3)$.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have set the following core and cladding relationships expressed by: $0 < ([n_1-n_3]/n_3) < 0.04$, $0 < ([n_1-n_3]/n_3) < 0.01$, and $0.3\alpha([n_2-n_3]/n_3)$. Since AAPA is clear to disclose that there is possible to be in the ranges as recited above (pg. 1, lines 28-30) and since AAPA does not specify any added advantages to have core-cladding relationships expressed within the constraints of these expressions, one of ordinary skill in the art would recognize that conforming to these expressions is a matter of design and need-based optical applications.

7. As per claim 27, AAPA discloses an optical function device, however, AAPA fails to specifically disclose the optical function device as any structure that performs at least one of generating, modifying, and measuring at least one of the amplitude, frequency, wavelength, dispersion, timing, propagation direction, and polarization properties of one or more light pulses.

Wojnarowski discloses an optical chip with an optical function device (fig. 7, ref. 50, 52) that performs at least one of generating, modifying, and measuring at least one of the amplitude, frequency, wavelength, dispersion, timing, propagation direction, and polarization properties of one or more light pulses (col. 6, lines 58-65).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to an optical function device that performs at least one of

generating, modifying, and measuring at least one of the amplitude, frequency, wavelength, dispersion, timing, propagation direction, and polarization properties of one or more light pulses since one would be motivated to achieve any of these functions on an optical chip. One of ordinary skill in the art would recognize these functions as well known and defined on the basis of performance and function needs.

8. As to claim 36 and 40-42, AAPA discloses the optical chip as recited above with a second chip including an emitting/receiving optical device, which may also be an external large mode field size dielectric waveguide, to optically connect to the large mode size dielectric waveguide of the first chip (pg. 1, lines 20-22).

9. Claims 5-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over AAPA and Wojnarowski, in view of Hammer (U.S. Patent No. 4,776,720).

AAPA and Wojnarowski disclose the optical chip as recited above with waveguide coupling devices (fig. 7, ref. 72, 74).

However, the references fail to specifically disclose a coupler that couples the low minimum bending radius dielectric waveguide to the large mode field size dielectric waveguide, and which has a first dielectric channel waveguide including a first core material having a first tapered region surrounded by a cladding material, a second dielectric channel waveguide including a second core material having a second tapered region surrounded by the cladding material such that all of the second tapered region being completely embedded within the first tapered region, where a first mode for

propagating lightwaves defined by the first dielectric channel waveguide gradually transforms into a second mode defined by the second dielectric channel waveguide. Furthermore, the references fail to teach that the first and second tapered region narrow toward each other and are graded in the horizontal and vertical directions.

Hammer discloses an optical waveguide coupler (fig. 1, ref. 10) that includes a first core material (fig. 1, ref. 18) having a first tapered region (fig. 1, ref. 18a) surrounded by a cladding material (fig. 1, ref. 16), a second dielectric channel waveguide including a second core material (fig. 1, ref. 20) having a second tapered region (fig. 1, ref. 20a) surrounded by the cladding material such that all of the second tapered region being completely embedded within the first tapered region (fig. 1, ref. 22), where a first mode for propagating lightwaves defined by the first dielectric channel waveguide gradually transforms into a second mode defined by the second dielectric channel waveguide (col. 2, lines 43-60). Furthermore, the reference teaches that the first and second tapered region narrow toward each other (fig. 1, ref. 22) and are graded in the horizontal and vertical directions.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included a tapered coupler device as recited above in an optical chip to couple the low minimum bending radius dielectric waveguide to the large mode field size dielectric waveguide since one would be motivated to effective transition the first mode of the large mode field size dielectric waveguide to the second mode of the low minimum bending radius dielectric waveguide (col. 2, lines 43-60). Not only does such a coupler achieve this, but a tapered coupler also allows the coupling of light

from waveguides having different specific geometries and materials, such as from various layers to one that has fewer layers, and all the while being able to have controlled coupling precision (col. 1, lines 26-40).

10. Claims 21-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over AAPA and Wojnarowski, in view of Carnevale et al. (U.S. Patent No. 4,412,722, from hereinafter "Carnevale").

AAPA and Wojnarowski disclose the optical chip as recited above with a low minimum bending radius dielectric waveguide (pg. 2, lines 15-17) having a high index core material. However, the references fail to specifically disclose a graded index region between the rough sides of the core and cladding to transition from high to low indices.

Carnevale discloses a low bend radius waveguide with a graded index region (abstract).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included a graded index region between the rough sides of the core and cladding to transition from high to low indices since one would be motivated to minimize dispersion and therefore to maximize bandwidth (abstract). Furthermore, improved field confinement adds to the overall lower clad-to-core ratios, lower cabling, microbending, and curvature-induced losses (abstract), which all ultimately serve to information and data transmission of optical communication systems. Furthermore, with respect to claim 26, it has been held that a recitation with respect to

the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex parte Masham, 2 USPQ2d 1647 (1987).

11. Claims 37-38 are rejected under 35 U.S.C. 103(a) as being unpatentable over AAPA and Wojnarowski, in view of Joannopoulos et al. (U.S. Patent No. 5,955,749, from hereinafter "Joannopoulos").

AAPA and Wojnarowski disclose the optical chip as recited above with a second chip including an emitting/receiving optical device, which may also be an external large mode field size dielectric waveguide, to optically connect to the large mode size dielectric waveguide of the first chip, however, the references fail to specifically disclose the application of an anti-reflective coating on either of the waveguides.

Joannopoulos discloses an optical chip with waveguides that have anti-reflective coatings (col. 1, lines 46-48).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have applied anti-reflective coatings to the waveguides since one would be motivated to further reduces optical losses (col. 1, lines 46-48) during transmission between the waveguides.

Response to Arguments

12. Applicant's arguments filed October 13, 2004 have been fully considered but they are not persuasive.

Applicant's main argument is that there is no motivation to combine AAPA and Wojnarowski and asserts that such a combination is "flawed." Although Applicant admits that AAPA clearly teaches "at least one large mode field size dielectric waveguide," "at least one low minimum bending radius dielectric waveguide," and "at least one optical function...connected to the low minimum bending radius waveguide," AAPA fails to specifically disclose is that these elements are fabricated monolithically on one substrate.

First, even though the product-by-process limitation "fabricated" is recognized as limited by and defined by the process, determination of patentability is based on the product itself. The patentability of a product does not depend on its method of production. If the product in the product-by-process claim is the same as or obvious from a product of the prior art, the claim is unpatentable even though the prior art product was made by a different process. *In re Thorpe*, 227 USPQ 964, 966 (Fed. Cir. 1985). See also MPEP 2113.

Second, even if this is deemed to be patentable limitation, Wojnarowski discloses an optical chip with dielectric waveguides (col. 2, lines 14-16) and optical function devices (fig. 2, ref. 50, 52) are fabricated monolithically on a single substrate (fig. 2, ref. 54). While Applicant argues that AAPA's mentioning of the possible drawbacks prevents such a combination, Examiner notes that these drawbacks are not necessarily apparent. First, AAPA admits that these drawbacks arise when low index difference waveguides are used. However, nowhere in Applicant's claimed invention is that recited. Moreover, the purpose of the Wojnarowski reference is not to disclose those

Art Unit: 2871

elements, but to provide teaching and motivation for combining the elements taught in AAPA can be "fabricated monolithically on a single substrate." If Wojnarowski disclosed "at least one large mode field size dielectric waveguide," "at least one low minimum bending radius dielectric waveguide," and "at least one optical function...connected to the low minimum bending radius waveguide," there would be no reason to include an obviousness rejection. Clearly, the Wojnarowski reference provides more than sufficient motivation for one of ordinary skill in the art at the time the invention was made to arranged a large mode field size dielectric waveguide, a low minimum bending radius dielectric waveguide, and an optical function monolithically on a single substrate since one would be motivated to provide an optimum platform for a high density interconnect structure (col. 1, lines 20-35). This not only provides stability but also high compatibility with many other interconnections, including external waveguides and optical devices (col. 2, lines 61-67).

And while Applicant makes other arguments regarding the use of other prior cited references, such as the Hammer, Carnevale, and Joannopoulos references, Applicant's arguments are pertain to the same discussion above.

Therefore, Examiner holds to the validity of the references and maintains the rejection.

Conclusion


Art Unit: 2871

13. Any inquiry concerning this communication or earlier communications from the examiner should be directed to George Y. Wang whose telephone number is 571-272-2304. The examiner can normally be reached on M-F, 8 am - 4:30 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Robert H. Kim can be reached on 571-272-2293. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

gw
April 29, 2005


ROBERT H. KIM
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800